

## Statement of Compliance

## **Requested Part**

05 June 2010 C31673-000 ( Part 1 of 1)

**RGEF1100** 

Status: Active

EU RoHS/ELV Code: Always EU RoHS/ELV Compliant

Solder Process Capability Code: Wave solder capable to 265°C

China RoHS: No Restricted Materials Above Threshold

Exemptions: No Substance>Threshold

REACH Oct 2008 SvHC Compliance: Contains no REACH October 2008 SvHC(s)
REACH Jan/Mar 2010 SvHC Compliance: Contains no REACH Jan/Mar 2010 SvHC(s)

Halogen Content: Not Low Halogen - contains Br or Cl > 900 ppm.

SPEL

David R. Bender

Director, Product Compliance

The part numbers that Tyco Electronics has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hex chrome, mercury, PBB, PBDE, and 0.01% for cadmium, or qualify for an exemption to above limits as defined in the Annex of the EU RoHS Directive. Note that any exemptions taken in this case would not include application specific exemptions (e.g. lead in solder for servers) as Tyco Electronics cannot determine where component products will be used.

Additionally, the part numbers that are identified as 5 of 6 compliant meet the material limits described above, except that these products have lead in the solderable interface only. These products may be suitable for use in an application that has an exemption for the use of lead in solder (e.g. servers, network infrastructure, etc).

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information provided by our suppliers. This information is subject to change.